November 1998

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# FDS9933A Dual P-Channel 2.5V Specified PowerTrench<sup>™</sup> MOSFET

## **General Description**

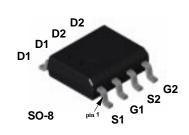
These P-Channel 2.5V specified MOSFETs are produced using Fairchild Semiconductor's advanced PowerTrench process that has been especially tailored to minimize the on-state resistance and yet maintain low gate charge for superior switching performance.

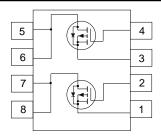
### Applications

- Load switch
- DC/DC converter
- Motor drives

## Features

- -3.8 A, -20 V.  $R_{DS(on)} = 0.075 \ \Omega \ @ V_{GS} = -4.5 \ V$  $R_{DS(on)} = 0.105 \ \Omega \ @ V_{GS} = -2.5 \ V.$
- Low gate charge (7nC typical).
- Fast switching speed.
- High performance trench technology for extremely low R<sub>DS(on)</sub>.
- High power and current handling capability.





# Absolute Maximum Ratings T\_=25°C unless otherwise noted

Symbol	Parameter		FDS9933A	Units
V <sub>DSS</sub>	Drain-Source Voltage		-20	V
V <sub>GSS</sub>	Gate-Source Voltage		<u>±</u> 8	V
I <sub>D</sub>	Drain Current - Continuous	(Note 1a)	-3.8	А
	- Pulsed		-20	
PD	Power Dissipation for Dual Operation		2.0	W
	Power Dissipation for Single Operation	(Note 1a)	1.6	
		(Note 1b)	1.0	
		(Note 1c)	0.9	
TJ, Tstg	Operating and Storage Junction Temperature Range		-55 to +150	°C

# **Thermal Characteristics**

R <sub>θJA</sub>	Thermal Resistance, Junction-to-Ambient	(Note 1a)	78	°C/W
R <sub>θ</sub> JC	Thermal Resistance, Junction-to-Case	(Note 1)	40	°C/W

## Package Marking and Ordering Information

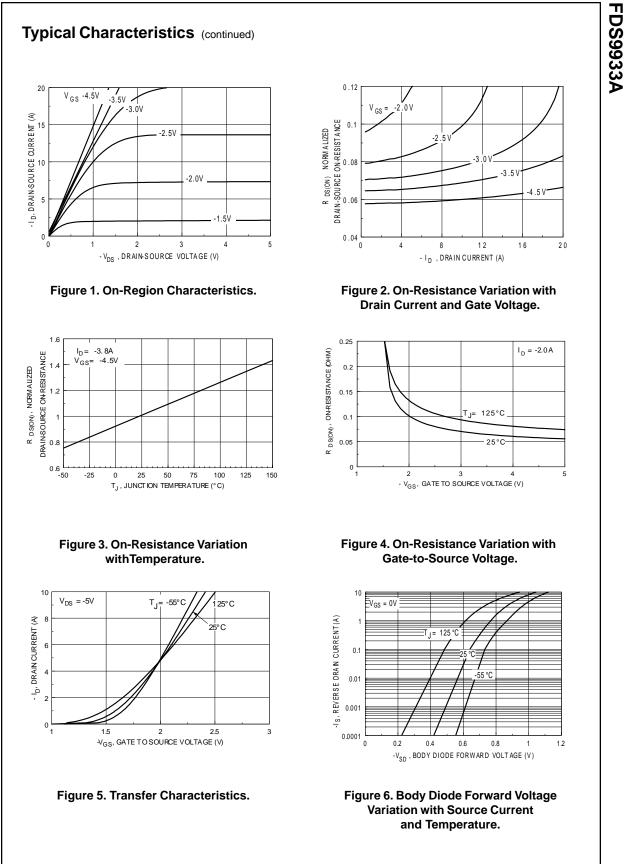
Device Marking	Device	Reel Size	Tape width	Quantity
FDS9933A	FDS9933A	13"	12mm	2500 units

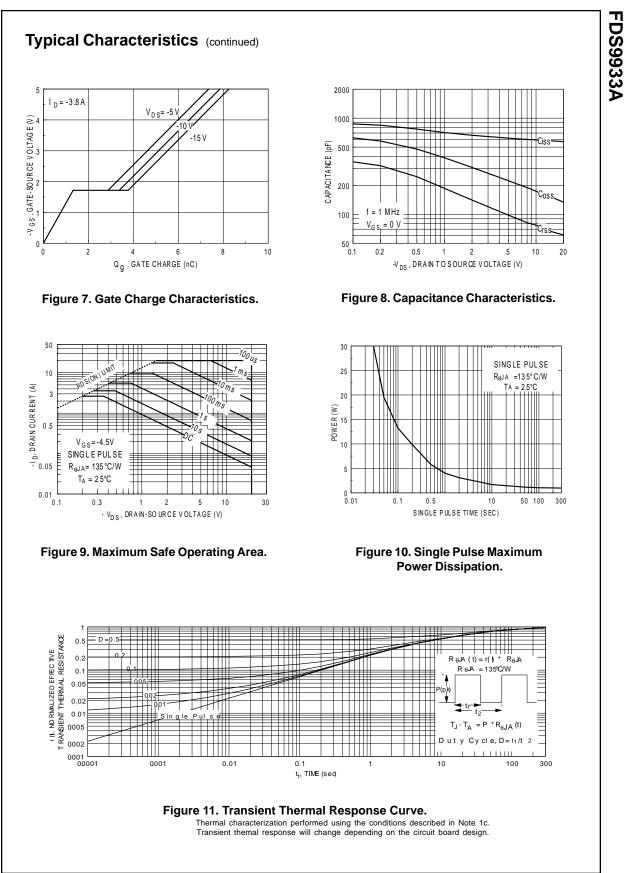
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Symbol	Parameter	Test Conditions	Min	Тур	Мах	Units
Off Char	acteristics					
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_D = -250 \mu A$	-20			V
$\Delta BV$ dss $\Delta T_{J}$	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$ , Referenced to $25^{\circ}\text{C}$		-16		mV/∘C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = -16 \text{ V}, V_{GS} = 0 \text{ V}$			-1	μA
I <sub>GSSF</sub>	Gate-Body Leakage, Forward	$V_{GS} = 8 V, V_{DS} = 0 V$			100	nA
I <sub>GSSR</sub>	Gate-Body Leakage, Reverse	$V_{GS}$ = -8 V, $V_{DS}$ = 0 V			-100	nA
on Char	acteristics (Note 2)					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{\text{DS}} = V_{\text{GS}}, I_{\text{D}} = -250 \ \mu\text{A}$	-0.4	-0.8	-1.5	V
ΔVGS(th) ΔTJ	Gate Threshold Voltage Temperature Coefficient	$I_D$ = -250 $\mu$ A, Referenced to 25°C		2.5		mV/∘C
R <sub>DS(on)</sub>	Static Drain-Source On-Resistance			0.058 0.086 0.084	0.075 0.12 0.105	Ω Ω Ω
D(on)	On-State Drain Current	$V_{GS} = -4.5 \text{ V}, N_{DS} = -5.0 \text{ V}$	-10	0.001	000	A
<b>g</b> FS	Forward Transconductance	$V_{DS} = -4.5 \text{ V}, \text{ I}_{D} = -3.8 \text{ A}$		10		S
ynamic	Characteristics					
viss	Input Capacitance	$V_{DS}$ = -10 V, $V_{GS}$ = 0 V, f = 1.0 MHz		600		pF
oss	Output Capacitance			175		pF
rss	Reverse Transfer Capacitance			80		pF
Switchin	g Characteristics (Note 2)					
t <sub>d(on)</sub>	Turn-On Delay Time	$V_{DD} = -5 V, I_D = -0.5 A,$		6	12	ns
tr	Turn-On Rise Time	$V_{\text{GS}}$ = -4.5 V, $R_{\text{GEN}}$ = 6.0 $\Omega$		9	18	ns
t <sub>d(off)</sub>	Turn-Off Delay Time			31	50	ns
t <sub>f</sub>	Turn-Off Fall Time			28	42	ns
Qg	Total Gate Charge	$V_{DS} = -10 V$ , $I_{D} = -3.8 A$ ,		7	10	nC
Q <sub>gs</sub>	Gate-Source Charge	V <sub>GS</sub> = -4.5 V		1.3		nC
Q <sub>gd</sub>	Gate-Drain Charge			2		nC
Drain-Sc	ource Diode Characteristics	and Maximum Ratings				
S	Maximum Continuous Drain-Source	e Diode Forward Current			-1.3	Α
/ <sub>SD</sub>	Drain-Source Diode Forward Voltage	$V_{GS} = 0 V, I_S = -1.3 A$ (Note 2)		-0.75	-1.2	V
	ins. $R_{\theta,JC}$ is guaranteed by design while $R_{\theta,JA}$ is	nt resistance where the case thermal reference is of a determined by the user's board design.		⊘ c) 135 ⊖ mou	° C/W whe inted on a of 2 oz. c	n 0.003 in²

FDS9933A Rev. C

FDS9933A





FDS9933A Rev. C

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